

- NOTES**
- PARTIAL REFERENCE DESIGNATIONS ARE SHOWN: PREFIX WITH ASSEMBLY OR SUBASSEMBLY DESIGNATION(S) OR BOTH FOR COMPLETE DESIGNATION.
 - COMPONENT VALUES ARE SHOWN AS FOLLOWS UNLESS OTHERWISE NOTED:
RESISTANCE IN OHMS
CAPACITANCE IN MICROFARADS
 - DENOTES ASSEMBLY.
 - DENOTES FRONT PANEL MARKING.
 - DENOTES REAR PANEL MARKING.
 - ⊙ DENOTES SCREWDRIVER ADJUST.
 - * AVERAGE VALUE SHOWN, OPTIMUM VALUE SELECTED AT FACTORY.
 - † OPTIMUM VALUE SELECTED AT FACTORY.
 - ▽ DENOTES CIRCUIT COMMON.
 - ▽ DENOTES REFERENCE COMMON.
 - ▽ DENOTES GUARD.
 - ≡ CHASSIS GROUND.
 - FIRST VOLTAGE IS COLD VOLTAGE (1ST 5 MINUTES); SECOND VOLTAGE (UNDERLINED) DENOTES VOLTAGE AFTER OVEN IS AT OPERATING TEMPERATURE (REFERENCED TO -OUTPUT).
 - SWITCH CONTACTS ON FRONT AND REAR OF EACH WAFER ARE IDENTICAL (DOUBLE CONTACTS ARE USED).
 - ← ← DENOTES SECOND APPEARANCE OF A CONNECTOR PIN.

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